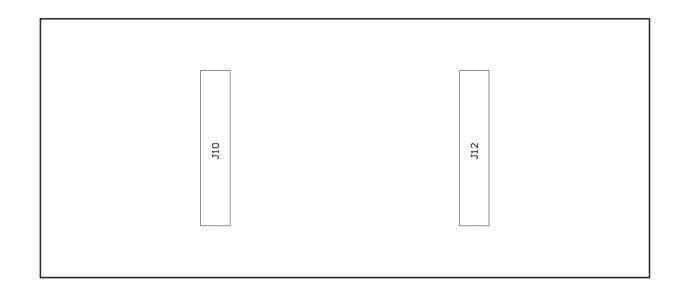


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00339	REV: E1	SUN REV:	Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 12/1/2	014 2:15:31	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00339	REV: E1	SVN REV: Not In VersionControl	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/1/2	014 2:15:31	PM	TEXAS INSTRUMENTS

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